

PolarP[™] Power MOSFET

IXTK32P60P

 $V_{DSS} = -600V$ $I_{D25} = -32A$ $R_{DS(an)} \le 350m\Omega$

P-Channel Enhancement Mode Avalanche Rated

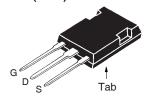


10-204 (17.114)	
	0
	N-DE
G D S	
S	†
	Tab

Symbol **Test Conditions Maximum Ratings** $T_{\perp} = 25^{\circ}C$ to $150^{\circ}C$ V_{DSS} - 600 $T_J = 25^{\circ}C$ to 150°C, $R_{GS} = 1M\Omega$ - 600 V_{DGR} V $\mathbf{V}_{\mathrm{GSS}}$ V Continuous ±20 ±30 Transient ٧ V_{GSM} $T_{c} = 25^{\circ}C$ - 32 Α I_{D25} $T_{\rm C} = 25^{\circ}$ C, Pulse Width Limited by $T_{\rm IM}$ - 96 Α I_{DM} $T_c = 25^{\circ}C$ \mathbf{I}_{A} \mathbf{E}_{AS} - 32 Α $T_{\rm c} = 25^{\circ} \rm C$ 3.5 J dv/dt $I_{_{S}} \le I_{_{DM}}, V_{_{DD}} \le V_{_{DSS}}, T_{_{J}} \le 150^{\circ}C$ 10 V/ns \mathbf{P}_{D} $T_{c} = 25^{\circ}C$ 890 W Т_Ј Т_{ЈМ} °C -55 ... +150 150 °C T_{stg} -55 ... +150 °С T_L 1.6mm (0.062 in.) from Case for 10s 300 °С Plastic Body for 10s 260 °С T_{SOLD} Mounting Force (PLUS247) 20..120/4.5..27 N/lb. M_{d} Mounting Torque (TO-264) 1.13/10 Nm/lb.in. PLUS247 Weight g TO-264 10 g



TO-264 (IVTK)



G = Gate D = Drain S = Source Tab = Drain

Features

- International Standard Packages
- Rugged PolarP™ Process
- Avalanche Rated
- Low Package Inductance

Easy to Mount

Advantages

- Space Savings
- High Power Density

Applications

- High-Side Switches
- Push Pull Amplifiers
- DC Choppers
- Automatic Test Equipment
- Current Regulators

Symbol (T _J = 25°C,	Test Conditions Unless Otherwise Specified)	Charae Min.	cteristic Typ.	Values Max	
BV _{DSS}	$V_{GS} = 0V, I_{D} = -250\mu A$	- 600			V
V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -1 \text{mA}$	- 2.0		- 4.0	V
I _{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA
I _{DSS}	$V_{DS} = V_{DSS}, V_{GS} = 0V$ $T_{J} = 125^{\circ}C$	С		- 50 - 250	•
R _{DS(on)}	$V_{GS} = -10V, I_{D} = 0.5 \bullet I_{D25}, \text{ Note 1}$			350	mΩ

3 - Source 4 - Drain



Symbol $(T_J = 25^{\circ}C,$	Test Conditions Unless Otherwise Specified)	Cha Min.	racteris Typ.	ic Values Max.
g _{fs}	$V_{DS} = -10V, I_{D} = 0.5 \bullet I_{D25}, \text{ Note 1}$	21	32	S
C _{iss}			11.1	nF
C _{oss}	$V_{GS} = 0V, V_{DS} = -25V, f = 1MHz$		925	pF
C _{rss}			77	pF
t _{d(on)}	Resistive Switching Times		37	ns
t _r	$V_{GS} = -10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D2S}$		27	ns
t _{d(off)}	$R_{c} = 1\Omega$ (External)		95	ns
t _f	n _G = 152 (External)		33	ns
$Q_{g(on)}$			196	nC
Q _{gs}	$V_{GS} = -10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$		54	nC
Q_{gd}			58	nC
R _{thJC}				0.14 °C/W
R _{thCS}			0.15	°C/W

Source-Drain Diode

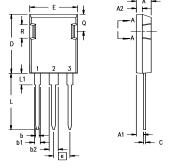
Symbol $(T_J = 25^{\circ}C, U)$	Test Conditions Ch Unless Otherwise Specified) Min	aracteris	tic Valu Max	
I _s	$V_{gs} = 0V$		- 32	Α
I _{sm}	Repetitive, pulse width limited by T_{JM}		-128	Α
V _{SD}	$I_F = -16A, V_{GS} = 0V, \text{ Note 1}$		- 2.8	V
$\left\{ egin{array}{ll} \mathbf{t}_{rr} & & \\ \mathbf{Q}_{RM} & & \\ \mathbf{I}_{RM} & & \end{array} ight\}$	$I_{_{\rm F}}$ = -16A, -di/dt = -150A/ μ s $V_{_{\rm R}}$ = -100V, $V_{_{ m GS}}$ = 0V	480 11.4 - 47.6		nS μC A

Note 1: Pulse test, $t \le 300\mu s$, duty cycle, $d \le 2\%$.

Terminals: 1 - Gate 2 - Drain

Dim.	Millimeter		Inches		
	Min.	Max.	Min.	Max.	
Α	4.82	5.13	.190	.202	
A1	2.54	2.89	.100	.114	
A2	2.00	2.10	.079	.083	
b	1.12	1.42	.044	.056	
b1	2.39	2.69	.094	.106	
b2	2.90	3.09	.114	.122	
С	0.53	0.83	.021	.033	
D	25.91	26.16	1.020	1.030	
Е	19.81	19.96	.780	.786	
е	5.46	5.46 BSC		.215 BSC	
J	0.00	0.25	.000	.010	
K	0.00	0.25	.000	.010	
L	20.32	20.83	.800	.820	
L1	2.29	2.59	.090	.102	
Р	3.17	3.66	.125	.144	
Q	6.07	6.27	.239	.247	
Q1	8.38	8.69	.330	.342	
R	3.81	4.32	.150	.170	
R1	1.78	2.29	.070	.090	
S	6.04	6.30	.238	.248	
Т	1.57	1.83	.062	.072	

PLUS 247™ Outline



Terminals:	1 - Gate
	2 - Drain
	3 - Source

Dim.	Millimeter Inches		nes	
	Min.	Max.	Min.	Max.
Α	4.83	5.21	.190	.205
A,	2.29	2.54	.090	.100
A ₂	1.91	2.16	.075	.085
b	1.14	1.40	.045	.055
b,	1.91	2.13	.075	.084
b_2	2.92	3.12	.115	.123
С	0.61	0.80	.024	.031
D	20.80	21.34	.819	.840
Е	15.75	16.13	.620	.635
е	5.45 BSC		.215 BSC	
L	19.81	20.32	.780	.800
L1	3.81	4.32	.150	.170
Q	5.59	6.20	.220	0.244
R	4.32	4.83	.170	.190



Fig. 1. Output Characteristics @ T_J = 25°C

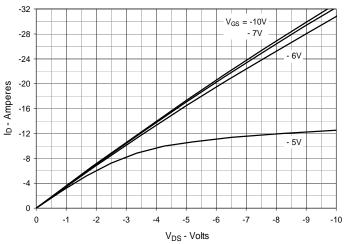


Fig. 2. Extended Output Characteristics @ T_J = 25°C

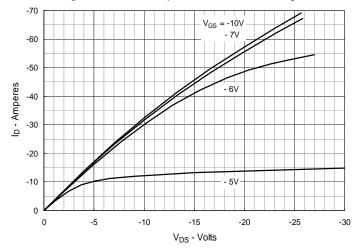


Fig. 3. Output Characteristics @ T_J = 125°C

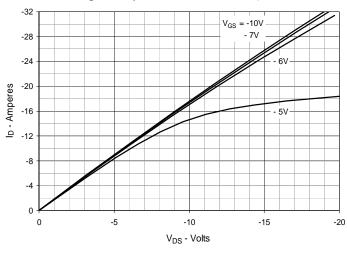


Fig. 4. $R_{DS(on)}$ Normalized to $I_D = -16A$ Value vs. Junction Temperature

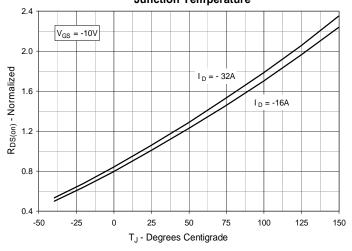


Fig. 5. $R_{DS(on)}$ Normalized to $I_D = -16A$ Value vs.

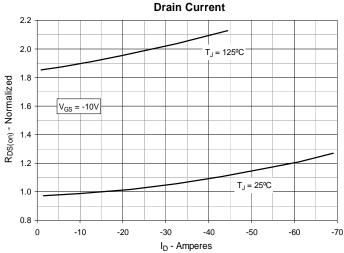
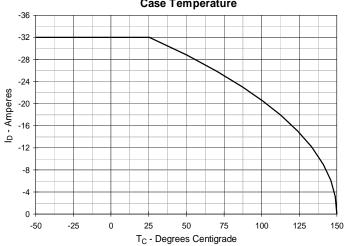
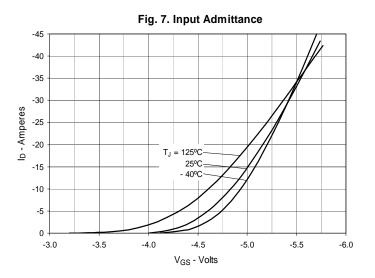


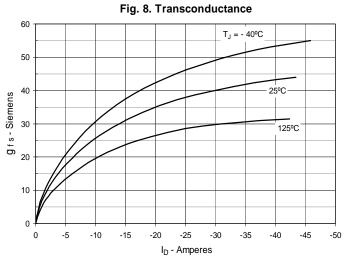
Fig. 6. Maximum Drain Current vs.

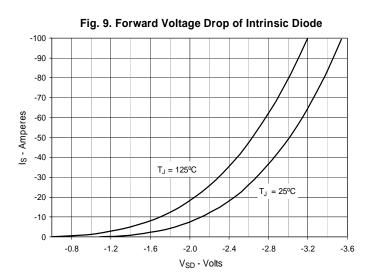
Case Temperature

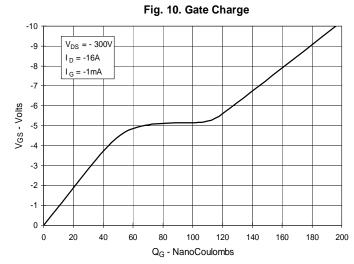


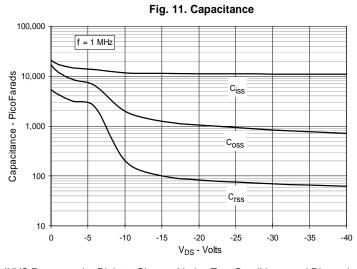


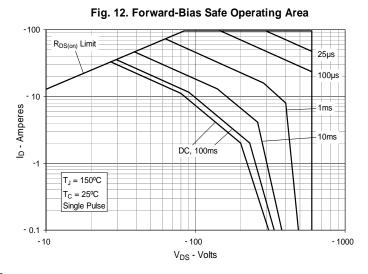












IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

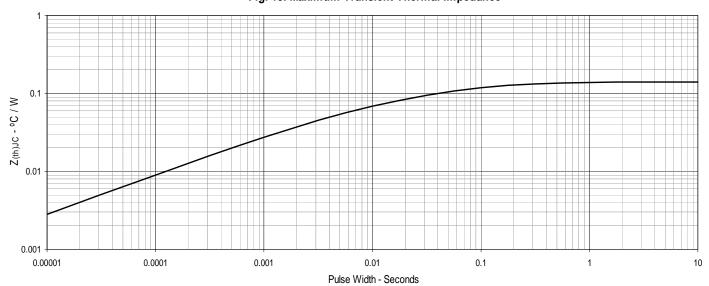


Fig. 13. Maximum Transient Thermal Impedance



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